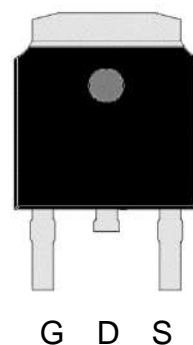


N-Channel Enhancement Mode Power MOSFET

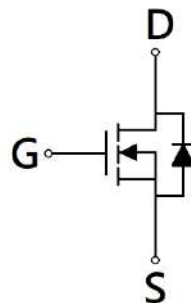
Features:

- Low On Resistance
- Low Gate Charge
- Fast Switching Characteristic

TO-252



| | |
|--|---------------|
| BV_{DSS} | 30V |
| $I_D @ V_{GS}=10V, T_C=25^\circ C$ | 56A |
| $I_D @ V_{GS}=10V, T_A=25^\circ C$ | 14A |
| $R_{DS(ON) typ. @ V_{GS}=10V, I_D=20A}$ | 3.4m Ω |
| $R_{DS(ON) typ. @ V_{GS}=4.5V, I_D=20A}$ | 4.6m Ω |



G : Gate S : Source D : Drain

Ordering Information

| Device | Package | Shipping |
|------------|---|------------------------|
| KJB3D8N03R | TO-252 (Pb-free lead plating and RoHS compliant package) | 2500 pcs / Tape & Reel |

Absolute Maximum Ratings (T_A=25°C)

| Parameter | Symbol | Limits | Unit |
|--|-----------------------------------|--------------------------|------|
| Drain-Source Voltage | V _{DS} | 30 | V |
| Gate-Source Voltage | V _{GS} | ±20 | |
| Continuous Drain Current @ V _{GS} =10V, T _C =25°C (silicon limit) *a | I _D | 64 | A |
| Continuous Drain Current @ V _{GS} =10V, T _C =25°C (package limit) *a | | 56 | |
| Continuous Drain Current @ V _{GS} =10V, T _C =100°C *a | | 40 | |
| Continuous Drain Current @ V _{GS} =10V, T _A =25°C *b | | 14 | |
| Continuous Drain Current @ V _{GS} =10V, T _A =70°C *b | | 11 | |
| Pulsed Drain Current *c | I _{DM} | 224 | |
| Continuous Body Diode Forward Current @ T _C =25°C *a | I _S | 37 | |
| Avalanche Current @ L=0.1mH | I _{AS} | 18 | |
| Avalanche Energy @ L=0.5mH | E _{AS} | 25 | mJ |
| Total Power Dissipation | P _D | T _C =25°C *a | W |
| | | T _C =100°C *a | |
| | | T _A =25°C *b | |
| | | T _A =70°C *b | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55~+150 | °C |

Thermal Data

| Parameter | Symbol | Steady State | Unit |
|--|------------------|--------------|------|
| Thermal Resistance, Junction-to-case | R _{θJC} | 2.8 | °C/W |
| Thermal Resistance, Junction-to-ambient *b | R _{θJA} | 58 | |

Note:

- *a. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- *b. The value of R_{θJA} is measured with the device mounted on 1 in²FR -4 board with 2 oz. copper, in a still air environment with T_A=25°C. The power dissipation P_D is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- *c. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and low duty cycles to keep initial T_J=25°C.

Electrical Characteristics (T_A=25°C, unless otherwise specified)

| Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|---------------------------|------|------|------|------|--|
| Static | | | | | |
| BV _{DSS} | 30 | - | - | V | V _{GS} =0V, I _D =250μA |
| V _{GS(th)} | 1 | - | 2.5 | | V _{DS} =V _{GS} , I _D =250μA |
| G _{FS} | - | 24 | - | S | V _{DS} =5V, I _D =10A |
| I _{GSS} | - | - | ±100 | nA | V _{GS} =±20V, V _{DS} =0V |
| I _{DSS} | - | - | 1 | μA | V _{DS} =24V, V _{GS} =0V |
| R _{DS(ON)} | - | 3.4 | 4.5 | mΩ | V _{GS} =10V, I _D =20A |
| | - | 4.6 | 6.5 | | V _{GS} =4.5V, I _D =20A |
| Dynamic | | | | | |
| C _{iss} | - | 1280 | - | pF | V _{DS} =15V, V _{GS} =0V, f=1MHz |
| C _{oss} | - | 860 | - | | |
| C _{rss} | - | 116 | - | | |
| R _g | - | 1 | - | Ω | f=1MHz |
| Q _g *1, 2 | - | 23 | - | nC | V _{DS} =15V, I _D =20A, V _{GS} =10V |
| Q _{gs} *1, 2 | - | 4 | - | | |
| Q _{gd} *1, 2 | - | 4.5 | - | | |
| t _{d(ON)} *1, 2 | - | 12 | - | ns | V _{DS} =15V, I _D =20A, V _{GS} =10V, R _{GS} =6Ω |
| t _r *1, 2 | - | 14 | - | | |
| t _{d(OFF)} *1, 2 | - | 39 | - | | |
| t _f *1, 2 | - | 10 | - | | |
| Source-Drain Diode | | | | | |
| V _{SD} *1 | - | 0.85 | 1.2 | V | I _S =20A, V _{GS} =0V |
| t _{rr} | - | 28 | - | ns | I _F =20A, dI _F /dt=100A/μs |
| Q _{rr} | - | 14 | - | nC | |

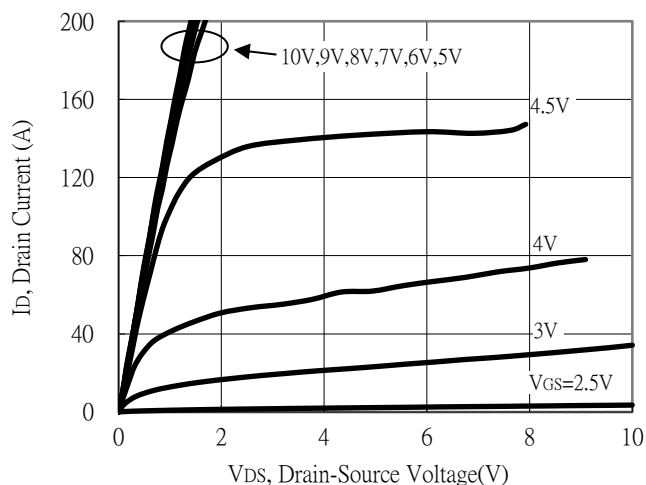
Note:

*1. Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

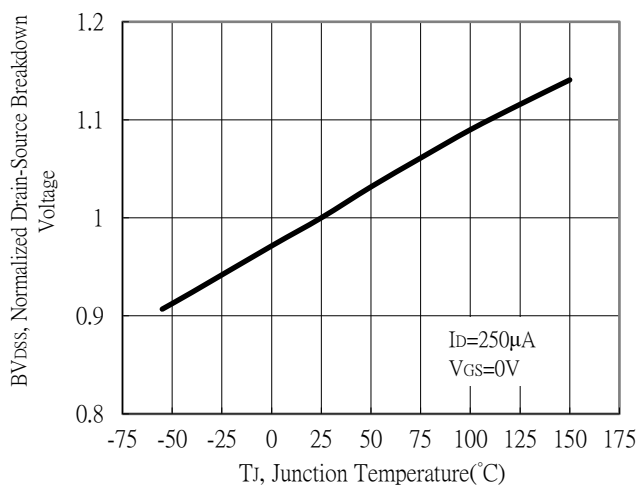
*2. Independent of operating temperature

Typical Characteristics

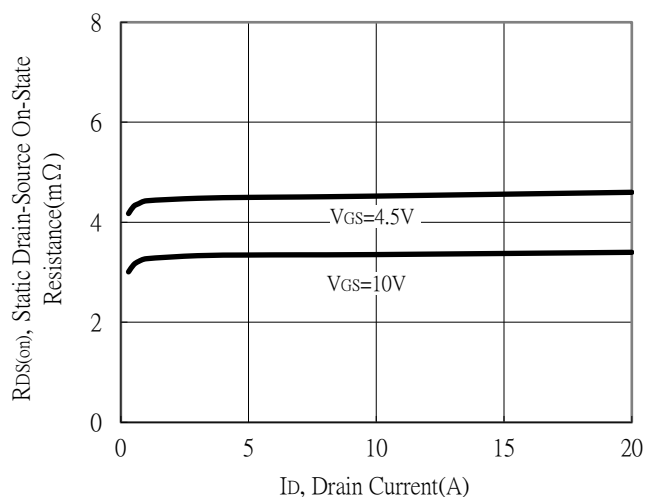
Typical Output Characteristics



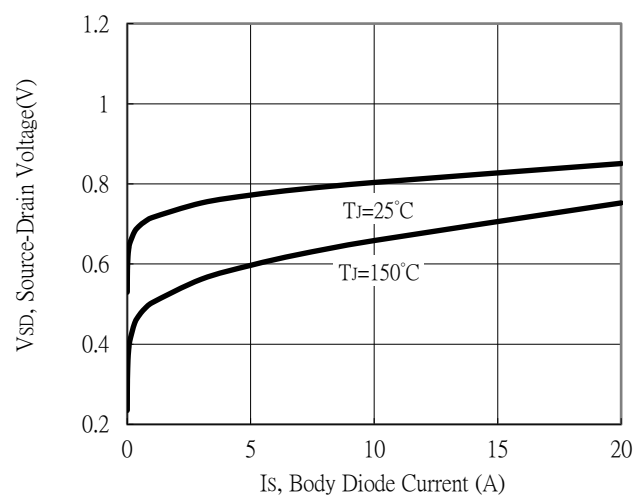
Breakdown Voltage vs Ambient Temperature



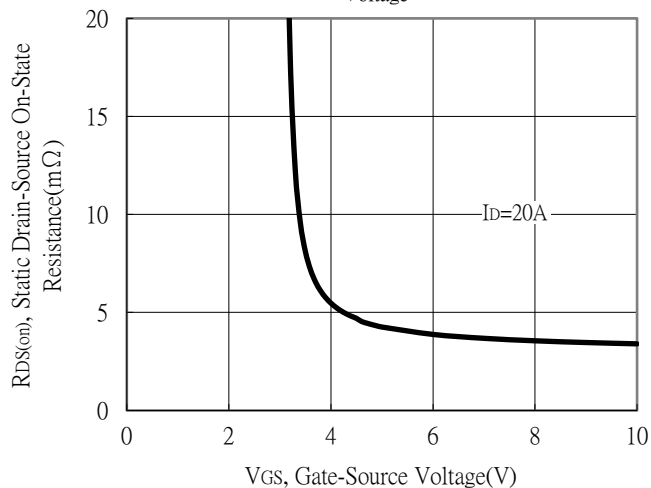
Static Drain-Source On-State resistance vs Drain Current



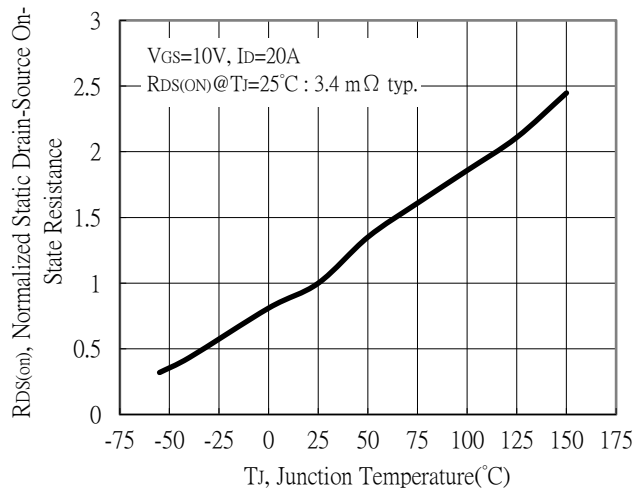
Body Diode Current vs Source-Drain Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

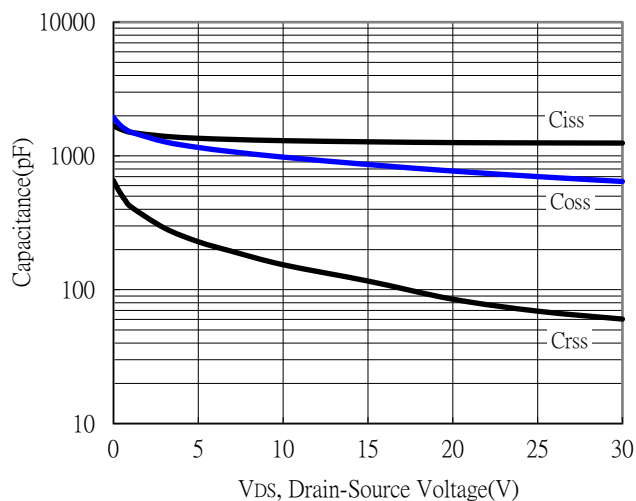


Drain-Source On-State Resistance vs Junction Temperature

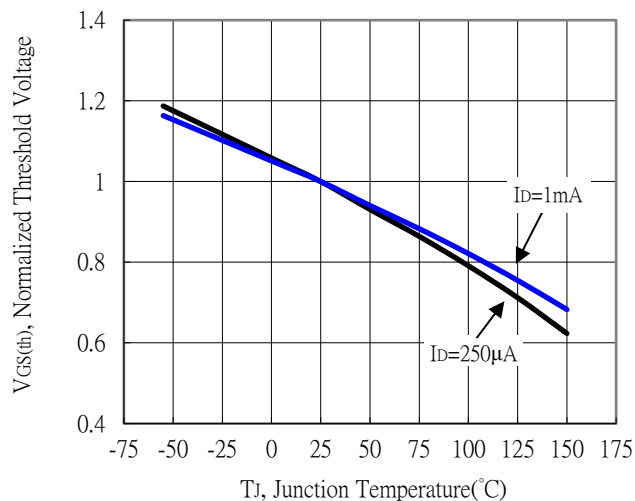


Typical Characteristics (Cont.)

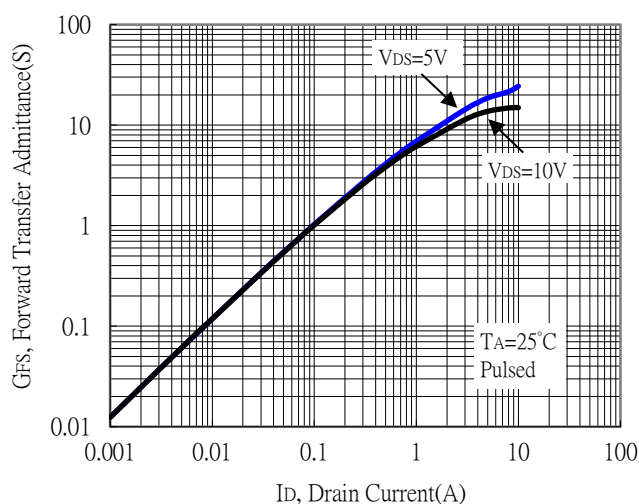
Capacitance vs Drain-to-Source Voltage



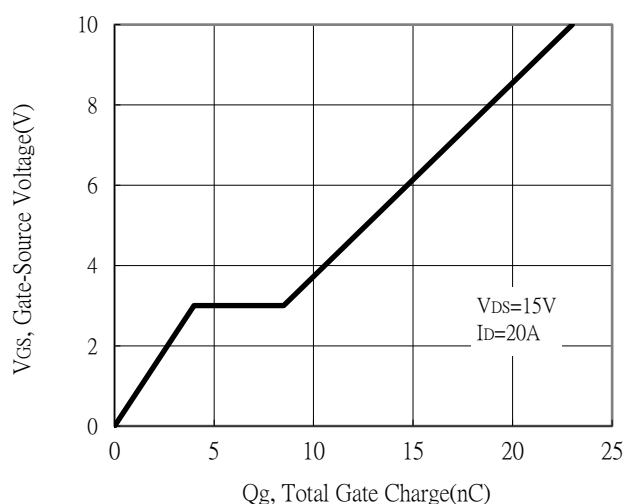
Threshold Voltage vs Junction Temperature



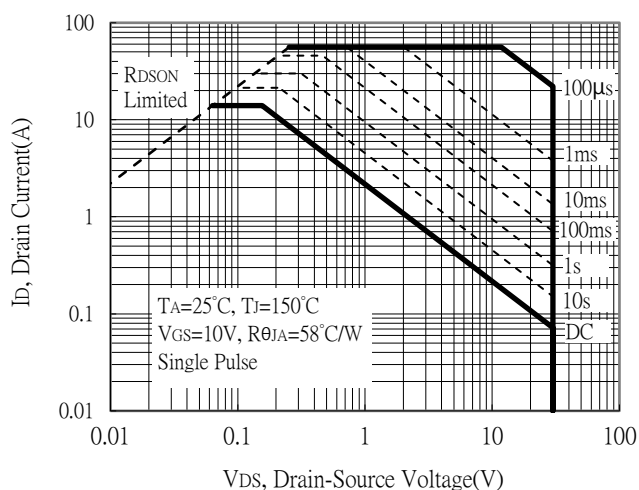
Forward Transfer Admittance vs Drain Current



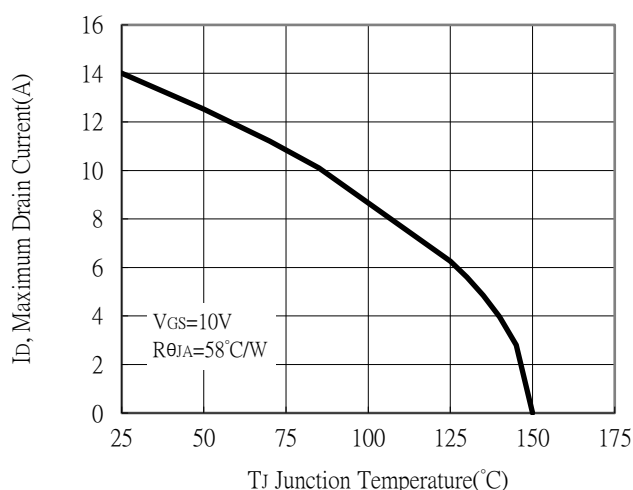
Gate Charge Characteristics



Maximum Safe Operating Area

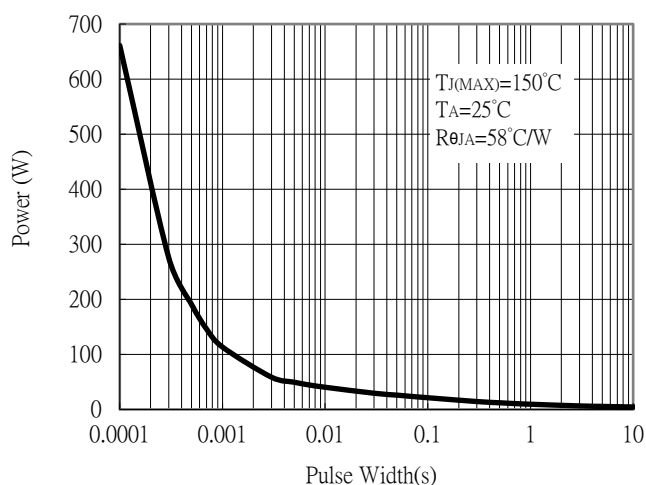


Maximum Drain Current vs Junction Temperature

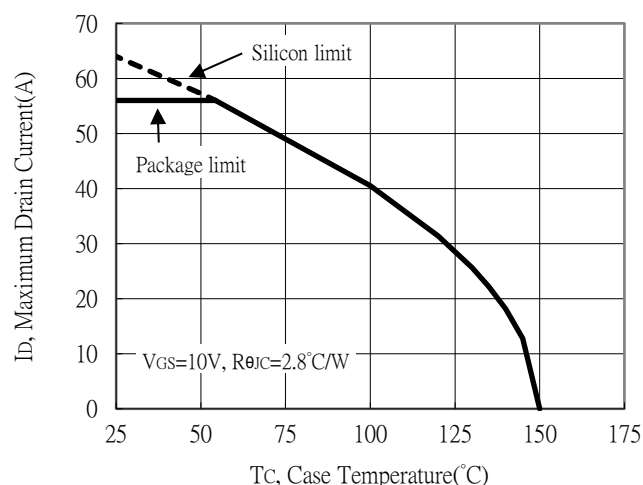


Typical Characteristics (Cont.)

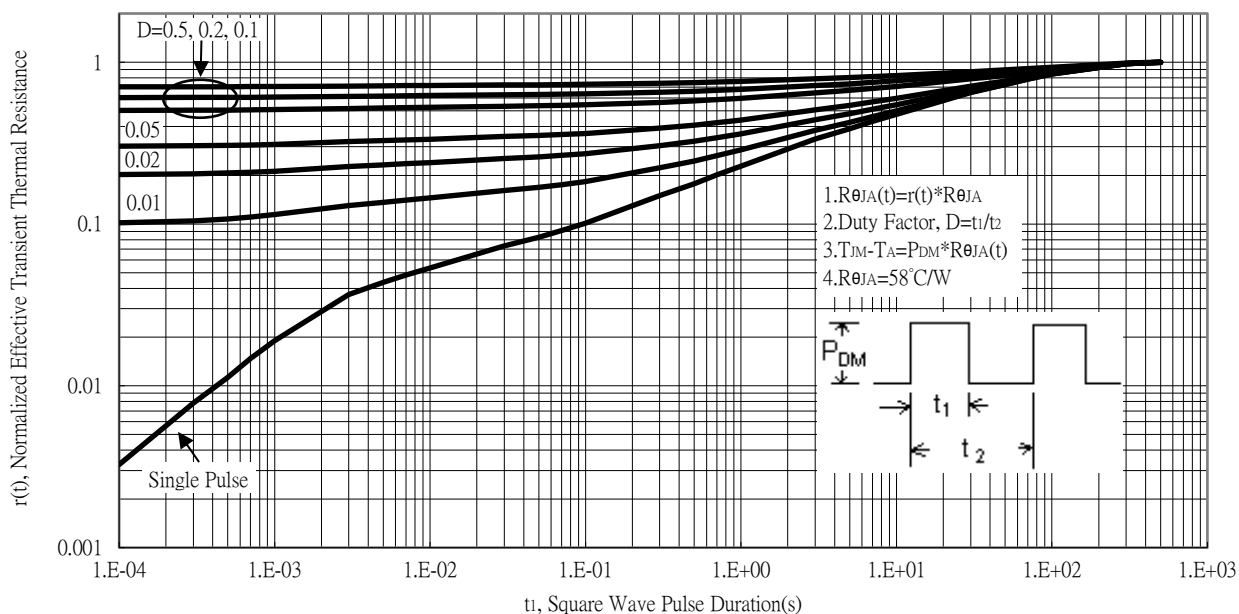
Single Pulse Power Rating, Junction to Ambient



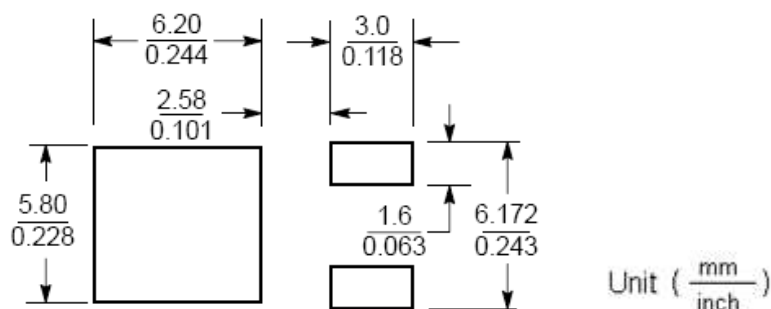
Maximum Drain Current vs Case Temperature



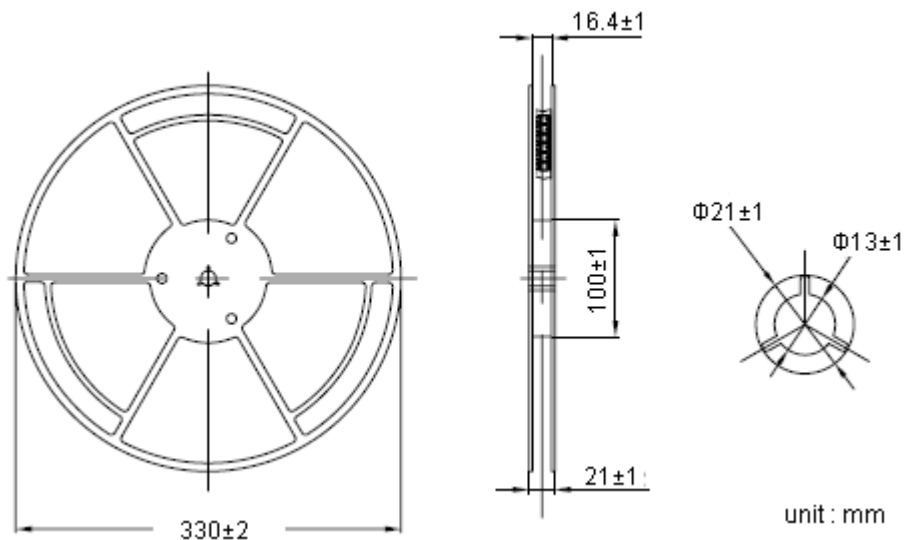
Transient Thermal Response Curves



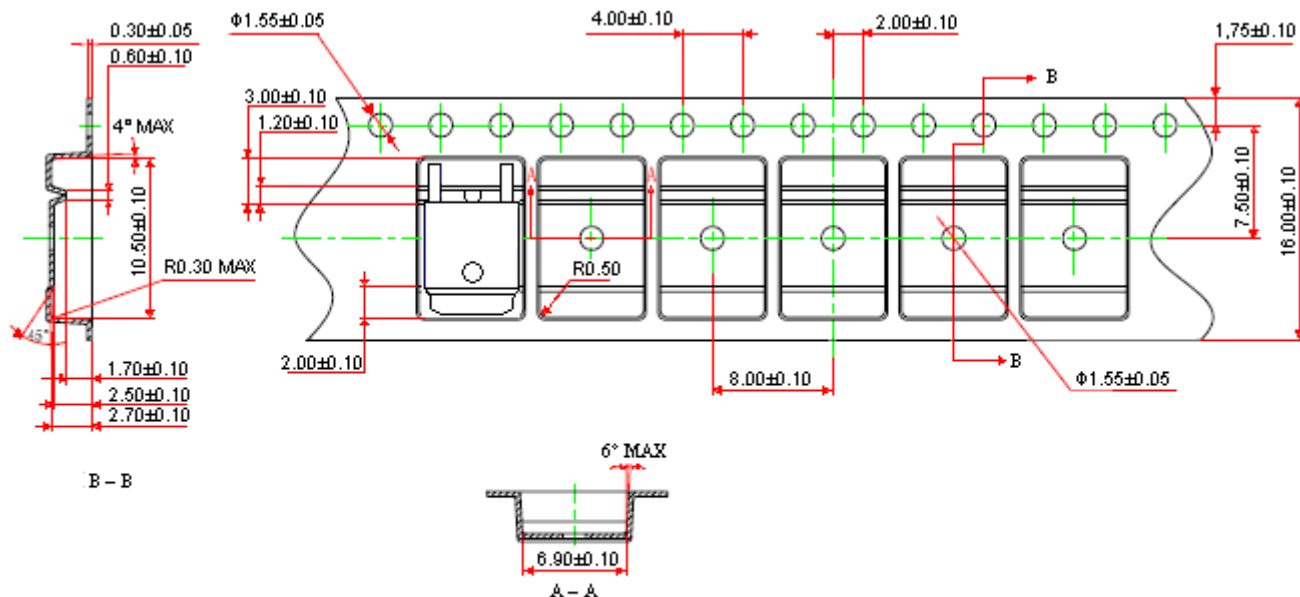
Recommended soldering footprint



Reel Dimension



Carrier Tape Dimension

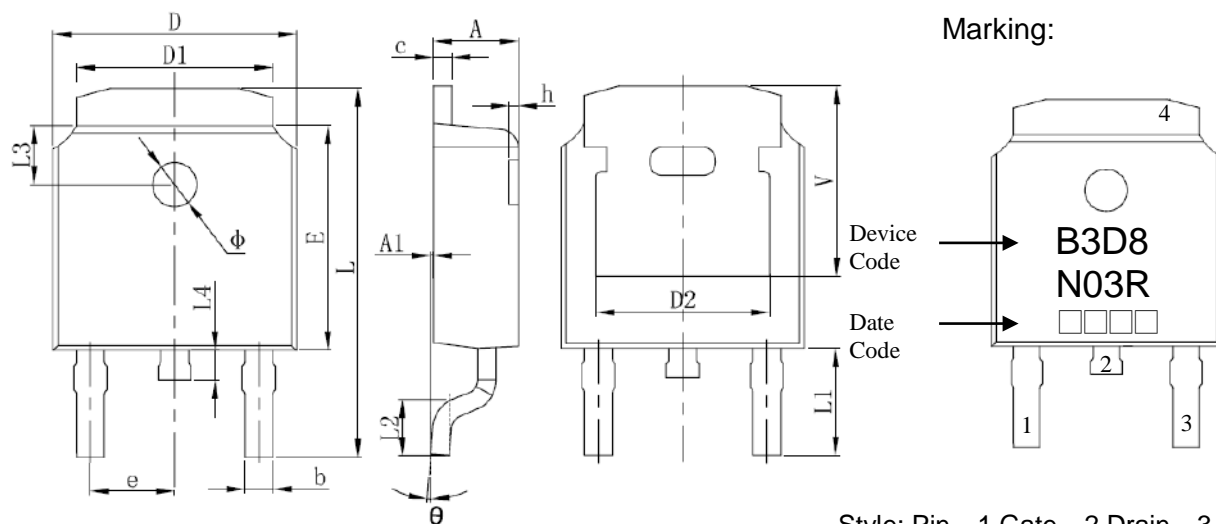


Notes:

1. 10 sprocket hole pitch cumulative tolerance ± 0.2 .
2. Camber not to exceed 1mm in 100mm.
3. Material: conductive black polystyrene, antistatic coated : $10^5 \Omega/\square \sim 10^{11} \Omega/\square$

unit : mm

TO-252 Dimension



Style: Pin 1.Gate 2.Drain 3.Source 4.Drain

Date Code(counting from left to right) :

1st code: year code, the last digit of Christian year

2nd code : month code, Jan→A, Feb→B, Mar→C,

Apr→D, May→E, Jun→F, Jul→G, Aug→H,

Sep→J, Oct→K, Nov→L, Dec→M

3rd and 4th codes : production serial number, 01~99

3-Lead TO-252 Plastic Surface Mount Package

| DIM | Inches | | Millimeters | | DIM | Inches | | Millimeters | |
|-----|--------|-------|-------------|-------|-----|--------|-------|-------------|--------|
| | Min. | Max. | Min. | Max. | | Min. | Max. | Min. | Max. |
| A | 0.087 | 0.094 | 2.200 | 2.400 | L | 0.382 | 0.406 | 9.712 | 10.312 |
| A1 | 0.000 | 0.005 | 0.000 | 0.127 | L1 | 0.114 | REF | 2.900 | REF |
| b | 0.025 | 0.030 | 0.635 | 0.770 | L2 | 0.055 | 0.067 | 1.400 | 1.700 |
| c | 0.018 | 0.023 | 0.460 | 0.580 | L3 | 0.063 | REF | 1.600 | REF |
| D | 0.256 | 0.264 | 6.500 | 6.700 | L4 | 0.024 | 0.039 | 0.600 | 1.000 |
| D1 | 0.201 | 0.215 | 5.100 | 5.460 | Φ | 0.043 | 0.051 | 1.100 | 1.300 |
| D2 | 0.190 | REF | 4.830 | REF | θ | 0° | 8° | 0° | 8° |
| E | 0.236 | 0.244 | 6.000 | 6.200 | h | 0.000 | 0.012 | 0.000 | 0.300 |
| e | 0.086 | 0.094 | 2.186 | 2.386 | V | 0.207 | REF | 5.250 | REF |